

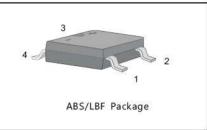
TB1S THRU TB10S

0.8A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

FEATURES:

- Glass Passivated Chip Juntion
- Reverse Voltage 50 to 1000 V
- Forward Current 0.8 A
- High Surge Current Capability
- Designed for Surface Mount Application
- MECHANICAL DATA
- Case: ABS/LBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 88mg 0.0029oz

IG	
DESCRIPTION	
Input Pin (~)	
Input Pin (~)	
Output Anode (+)	
Output Cathode (-)	
	DESCRIPTION Input Pin (~) Input Pin (~) Output Anode (+)



Maximum Ratings and Electrical characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	TB1S	TB2S	TB4S	TB6S	TB8S	TB10S	Units
Maximum Repetitive Peak Reverse Voltage	VRRM	100	200	400	600	800	1000	v
Maximum RMS voltage	V _{RMS}	70	140	280	420	560	700	v
Maximum DC Blocking Voltage	V _{DC}	100	200	400	600	800	1000	v
Average Rectified Output Current at Ta = 40 °C	lo			0	.8			А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	IFSM			2	5			A
Forward Voltage per element $\begin{array}{c} @I_F = 0.4A \\ @I_F = 0.8A \end{array}$	VF			1. 1.	.0 .1			v
Maximum DC Reverse Current at Rated DC Blocking Voltage @T _A =25 °C @T _A =100°C @T _A =125 °C	I _R			1	00 00 00			μA
Typical Junction Capacitance (Note1)	Cj			1	3			pF
Typical Thermal Resistance (Note2)	R _{eja} R _{ejl}				0 6			°C/W
Operating and Storage Temperature Range	Tj, T _{stg}			-55 ~	+150			°C

Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 1.3mm2 copper pad.

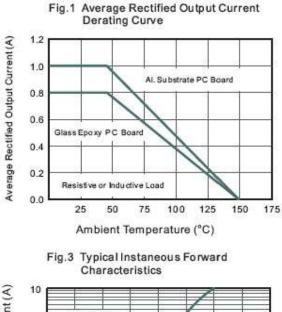
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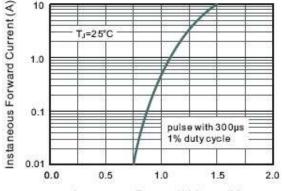
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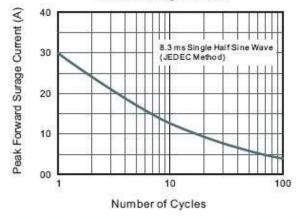
TB1S THRU TB10S





Instaneous Forward Voltage (V)

Fig.5 Maximum Non-Repetitive Peak Forward Surage Current



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Fig.2 Typical Reverse Characteristics

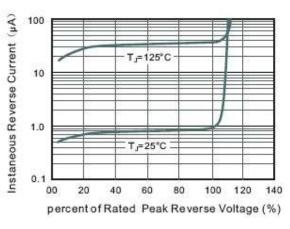
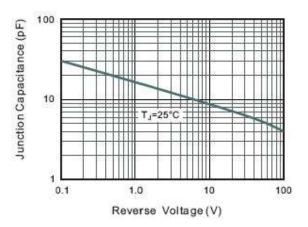


Fig.4 Typical Junction Capacitance



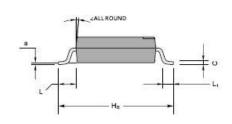


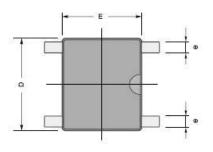
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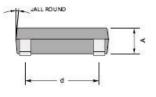
PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

ABS/LBF-栋



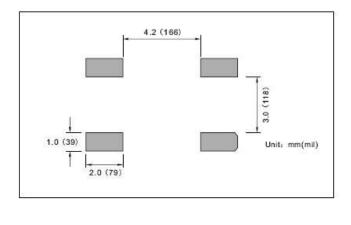




ABS/LBF mechanical data

UNIT		Α	С	D	Е	Hε	d	е	L	Lı	а	4
-	max	1.5	0.22	5.2	4.5	6.4	4.2	0.7	0.05			
mm	min	1.3	0.15	4.9	4.2	6.0	3.8	0.5	0.95	0.6	0.2	-70
500 4 00	max	59	8.7	205	177	252	165	28		24		1
mil	min	51	5.9	193	166	236	150	20	37	24	4	

The recommended mounting pad size



Marking

TB1S TB2S TB4S TB6S
TB4S
-04000040404
TB6S
TB8S
TB10S
×S



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